



# Electronic Filing System (EFS) Data Electronic Patent Application Submission USPTO Use Only

EFS ID:

62099

Application ID:

10781220

LEADFRAME PACKAGE FOR

Title of Invention:

**SEMICONDUCTOR DEVICES** 

First Named Inventor:

**KEITH EDWARDS** 

Domestic/Foreign Application:

**Domestic Application** 

Filing Date:

2002-08-24

Effective Receipt Date:

2004-06-04

Submission Type:

Information Disclosure

Statement

Filing Type:

Confirmation number:

1929

Attorney Docket Number:

AMKOR083C

Total Fees Authorized:

Digital Certificate Holder: cn=Mark B. Garred,ou=Registered Attorneys,ou=Patent and Trademark

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#### **TRANSMITTAL**

Electronic Version v1.1
Stylesheet Version v1.1.0

Title of Invention

LEADFRAME PACKAGE FOR SEMICONDUCTOR DEVICES

Application Number:

10/781220

Date:

2002-08-24

First Named Applicant:

KEITH M.

Confirmation Number:

1929

Attorney Docket Number: AMKOR083C

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Submitted by:	Elec. Sign.	Sign. Capacity	
MARK B. GARRED	/mbg/	Attorney	
Registered Number: 34823			

Documents being submitted

**Files** 

us-ids

IDS5-usidst.xml

us-ids.dtd

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### Comments



## **ELECTRONIC INFORMATION DISCLOSURE STATEMENT**

Electronic Version v18
Stylesheet Version v18.0

Title of Invention

LEADFRAME PACKAGE FOR SEMICONDUCTOR DEVICES

Application Number:

10/781220

Confirmation Number:

1929

First Named Applicant:

**KEITH EDWARDS** 

Attorney Docket Number: AMKOR083C

Art Unit:

2815

Search string:

( 6143981 or 6169329 or 6177718 or 6181002 or 6184573 or 6184465 or 6194777 or 6197615

or 6198171 or 6201186 or 6201292 or 6204554 or 6208023 or 6208020 or 6208021 or 6211462

or 6218731 or 6222258 or 6222259 or 6225146 or 6229200 or 6229205 or 6239367 or 6239384 or 6242281 or 6256200 or 6258629 or 6281566 or 6281568 or 6282095 or 6285075 or 6291271

or 6291273 or 6294100 or 6294830 or 6295977 or 6297548 or 6303984 or 6303997 or 6307272 or 6309909 or 6316822 or 6316838 or 6323550

or 6326243 or 6326244 or 6326678 or 6335564

or 6337510 or 6339255 ).pn.

## **US Patent Documents**

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

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## Signature

Examiner Name	Date